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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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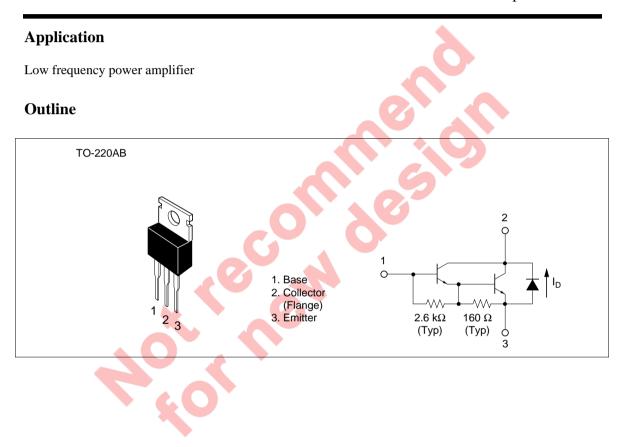
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Silicon NPN Triple Diffused



ADE-208-915 (Z) 1st. Edition September 2000



Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

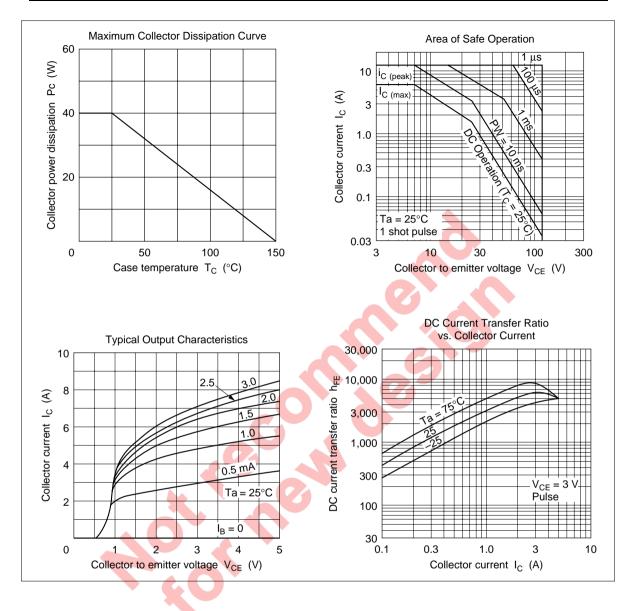
Item	Symbol	Ratings	Unit V	
Collector to base voltage	V _{CBO}	120		
Collector to emitter voltage	V _{CEO}	V _{CEO} 120		
Emitter to base voltage	V _{EBO}	V _{EBO} 7		
Collector current	I _c	6	А	
Collector peak current	I _{C(peak)}	12	А	
Collector power dissipation	P _c *1	40	W	
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	
C to E diode forward current	۱ _D *1	6	А	
Note: 1. Value at $T_c = 25^{\circ}C$.				

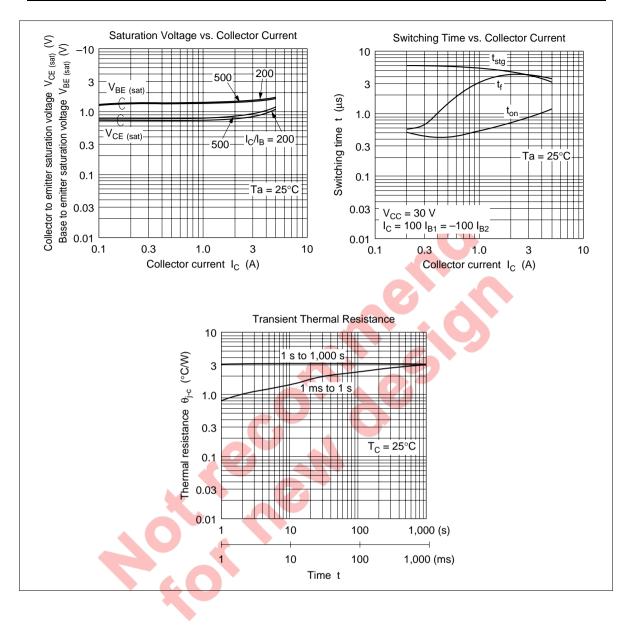
Electrical Characteristics (Ta = 25°C)

Note: 1. Value at $T_c = 25^{\circ}C$.						
Electrical Characteristic	25°C)					
Item	Symbol	Min	Тур	Мах	Unit	Test conditions
Collector to emitter breakdown voltage	$V_{(\text{BR})\text{CEO}}$	120		20	V	I_{c} = 25 mA, R_{BE} = ∞
Emitter to base breakdown voltage	$V_{(BR)EBO}$	7	-	0	V	$I_{\rm E} = 50$ mA, $I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	-	-	100	μΑ	$V_{CB} = 120 \text{ V}, \text{ I}_{E} = 0$
	I _{CEO}	-		10	μA	V_{ce} = 100 V, R_{be} = ∞
DC current transfer ratio	h _{FE}	1000	-	20000		$V_{ce} = 3 V, I_c = 3 A^{*1}$
Collector to emitter saturation	V _{CE(sat)1}	A	_	1.5	V	$I_{\rm C} = 3 \text{ A}, I_{\rm B} = 6 \text{ mA}^{*1}$
voltage	V _{CE(sat)2}		—	3.0	V	$I_{\rm C} = 6 \text{ A}, I_{\rm B} = 60 \text{ mA}^{*1}$
Base to emitter saturation	V _{BE(sat)1}	—	_	2.0	V	$I_{\rm C} = 3 \text{ A}, I_{\rm B} = 6 \text{ mA}^{*1}$
voltage	V _{BE(sat)2}	—	_	3.5	V	$I_{\rm C} = 6 \text{ A}, I_{\rm B} = 60 \text{ mA}^{*1}$
C to E diode forward voltage	VD	—	_	3.0	V	$I_{\rm D} = 6 \ {\rm A}^{\star 1}$
Turn on time	t _{on}	_	0.6		μs	$I_{\rm C} = 3 \text{ A}, I_{\rm B1} = -I_{\rm B2} = 6 \text{ mA}$
Storage time	t _{stg}	_	7.0	_	μs	_
Fall time	t _f	_	2.0	_	μs	

Note: 1. Pulse test.

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